

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4296469

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
XU CHEN	02/16/2017
ZHENG LI	02/16/2017
JICHEN XIAO	02/16/2017

RECEIVING PARTY DATA

Name:	HISENSE CO., LTD.
Street Address:	NO. 17 DONGHAIXI ROAD, SHINAN DISTRICT, SHANDONG
City:	QINGDAO
State/Country:	CHINA
Postal Code:	266071
Name:	HISENSE USA CORPORATION
Street Address:	7310 MCGINNIS FERRY ROAD
City:	SUWANEE
State/Country:	GEORGIA
Postal Code:	30024
Name:	HISENSE INTERNATIONAL CO., LTD.
Street Address:	NO. 218, QIANWANGANG ROAD, ECONOMIC AND TECHNICAL DEVELOPMENT ZONE, SHANDONG
City:	QINGDAO
State/Country:	CHINA
Postal Code:	266555

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15445944

CORRESPONDENCE DATA

Fax Number: (949)660-0809

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9496600761

Email: jcpatents@gmail.com

Correspondent Name: J.C. PATENTS

PATENT

Address Line 1: 4 VENTURE, SUITE 250
Address Line 4: IRVINE, CALIFORNIA 92618

ATTORNEY DOCKET NUMBER: LPTF2364

NAME OF SUBMITTER: JIAWEI HUANG

SIGNATURE: /JIAWEI HUANG/

DATE SIGNED: 02/28/2017

This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 3

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ASSIGNMENT WITH DECLARATION

WHEREAS, the undersigned Inventors:

CHEN, Xu;

LI, Zheng;

XIAO, Jichen

have invented certain new and useful improvements as described and set forth in the below identified application for United States Patent:

Title: **METHOD AND APPARATUS FOR CONTROLLING A LASER PROJECTION
 DEVICE**

[] Filed on: _____ Serial No.: _____

[X] Executed concurrently with the execution of this instrument

WHEREAS **(1)Hisense Co., Ltd.**
 (hereinafter termed "Assignee"), a corporation
residing at **No.17 Donghaixi Road, Shinan District, Qingdao, Shandong, P.R.C.
 266071**

(2) HISENSE USA CORPORATION
 (hereinafter termed "Assignee"), a corporation
residing at **No.7310 McGinnis Ferry Road, Suwanee, GA, U.S.A. 30024**

(3) Hisense International Co., Ltd.
 (hereinafter termed "Assignee"), a corporation
residing at **No.218 Qianwangang Road, Economic and Technical Development Zone,
 Qingdao, Shandong, P.R.C. 266555**

desires to acquire the entire right, title, and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or disclosed jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and al patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the

entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Full name of the first inventor: CHEN, Xu

The first inventor's signature: CHEN, Xu Date: February 16, 2017

Full name of the second inventor: **LI, Zheng**

The second inventor's signature: LI Zheng Date: February 16, 2017

Full name of the third inventor: **XIAO, Jichen**

The third inventor's signature: XIAO Jichen Date: February 16, 2017